

1 Scope

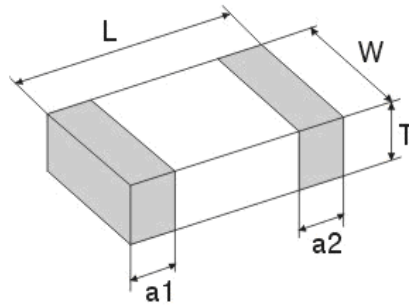
This specification applies to the HDLB series of multilayer chip large current bead.

2 Product Identification

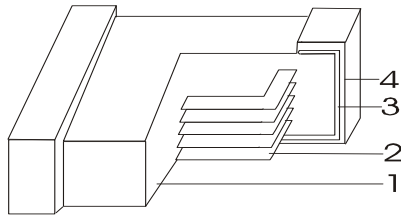
HDLB 2012 M 121 T 2R0 -LF
 ① ② ③ ④ ⑤ ⑥ ⑦

- ① Product Symbol (HDLB:)
- ② Dimensions
- ③ Material Code (E、M、Q)
- ④ Impedance Value
- ⑤ Packaging Style (B: Bulk; T: Tape & Reel)
- ⑥ Rated Current (1R5:1500m A、2R0: 2000mA)
- ⑦ Lead Free

3 Appearance, Dimensions and Material



Type	Dimensions (mm) [inch]			
	L	W	T	a1, a2
0603 [0201]	0.60±0.05 [0.024±0.002]	0.30±0.05 [0.012±0.002]	0.30±0.05 [0.012±0.002]	0.15±0.05 [0.006±0.002]
1005 [0402]	1.00±0.15 [0.04±0.006]	0.50±0.15 [0.02±0.006]	0.50±0.15 [0.02±0.006]	0.25±0.10 [0.01±0.004]
1608 [0603]	1.60±0.15 [0.063±0.006]	0.80±0.15 [0.031±0.006]	0.80±0.15 [0.031±0.006]	0.30±0.20 [0.012±0.008]
2012 [0805]	2.00±0.20 [0.079±0.008]	1.25±0.20 [0.049±0.008]	0.85±0.20 [0.033±0.008]	0.50±0.30 [0.02±0.012]
3216 [1206]	3.20±0.20 [0.126±0.008]	1.60±0.20 [0.063±0.008]	1.10±0.30 [0.043±0.012]	0.50±0.30 [0.02±0.012]



	Composition	Material	Supplier
1	Base Material	Ferrite	Japan
2	Internal Conductor	Ag	Japan
3	Terminal Electrode	Ag	Japan
4	Terminal Electrode	Ni-Sn	USA

4 Testing Conditions

<Unless otherwise specified>

Temperature: Ordinary Temperature(5 to 35 °C)

Humidity: Ordinary Humidity (25 to 85% RH)

<In case of doubt>

Temperature: 20 ±2°C

Humidity: 60 to 75% RH

Atmospheric Pressure: 86 to 106 kPa

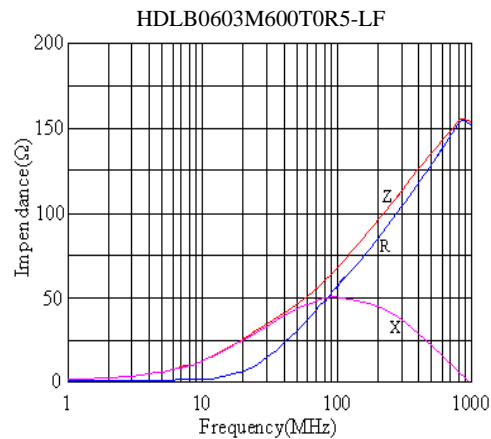
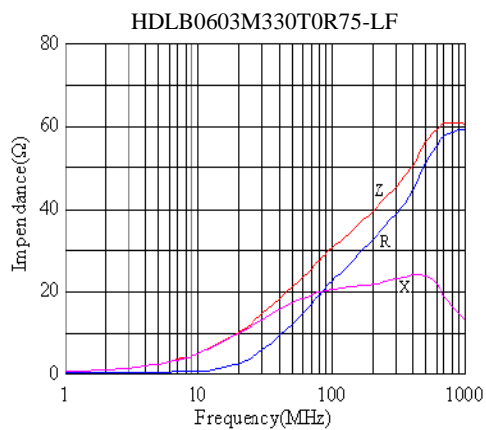
5 Rating

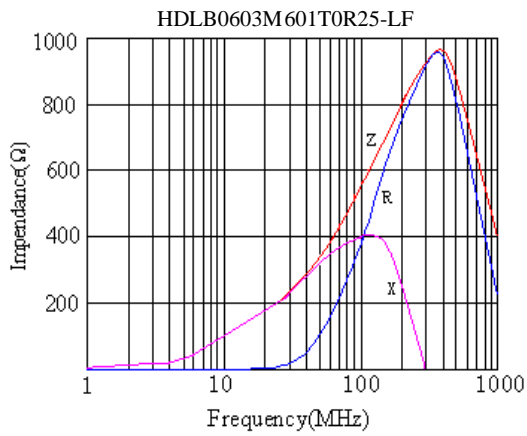
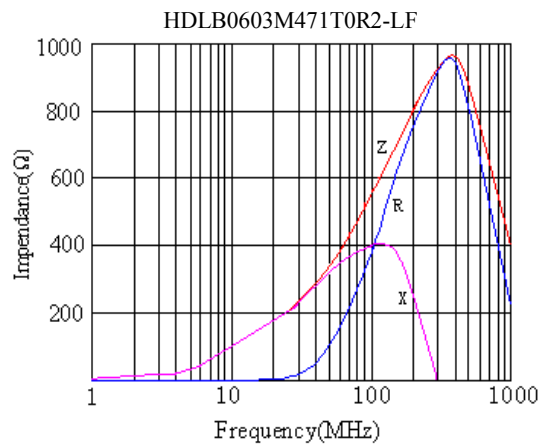
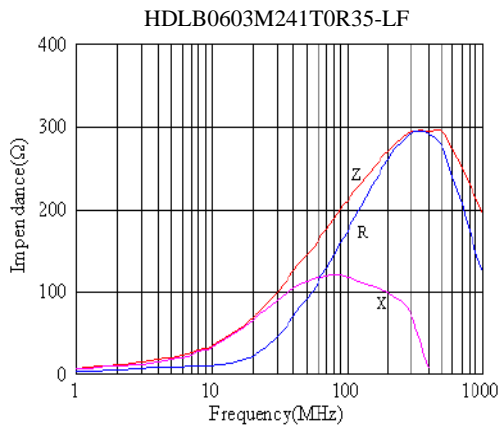
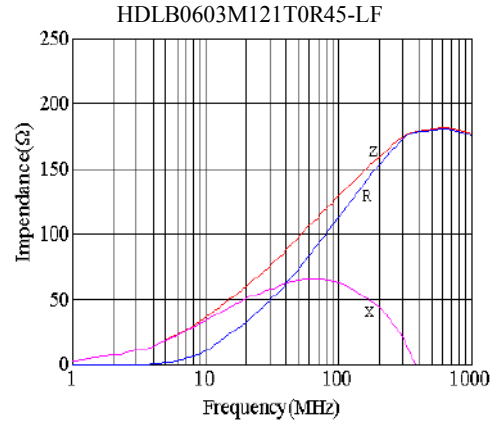
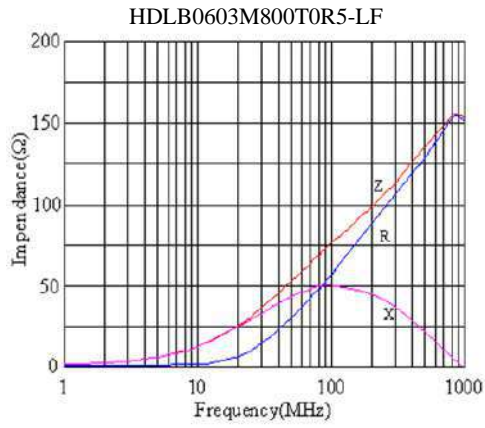
Operating Temperature Range : -55 to +125°C

Storage Temperature Range : -55 to +125°C

0603 Series

Part No.	Impedance (Ω) ±25%	Z Test Freq. (MHz)	RDC (Ω) /max	Ir(mA) /max
HDLB0603M330T0R75-LF	33	100	0.09	750
HDLB0603M600T0R5-LF	60	100	0.30	500
HDLB0603M800T0R5-LF	80	100	0.35	500
HDLB0603M121T0R45-LF	120	100	0.40	450
HDLB0603M241T0R35-LF	240	100	0.50	350
HDLB0603M471T0R2-LF	470	100	1.00	200
HDLB0603M601T0R25-LF	600	100	1.00	250



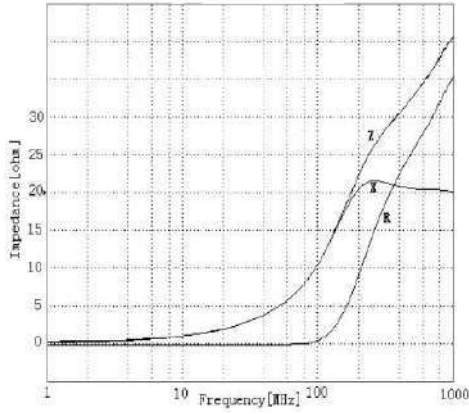


1005 Series

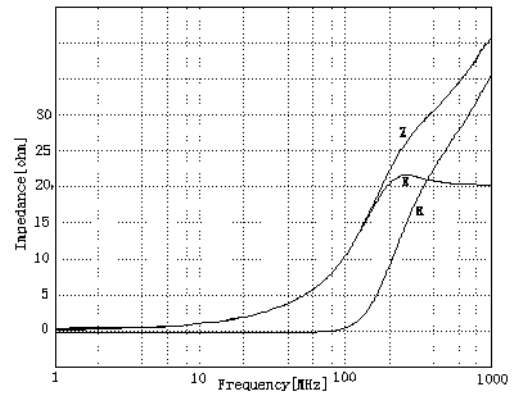
Part No.	Impedance (Ω) $\pm 25\%$	Z Test Freq. (MHz)	RDC (Ω) /max	Ir(mA) /max
HDLB1005M100T2R0-LF	10	100	0.05	2000
HDLB1005M110T2R0-LF	11	100	0.05	2000
HDLB1005M300T2R2-LF	30	100	0.05	2200
HDLB1005M310T1R5-LF	31	100	0.06	1500
HDLB1005M600T1R5-LF	60	100	0.13	1500
HDLB1005M800T1R5-LF	80	100	0.13	1500
HDLB1005M101T1R2-LF	100	100	0.10	1200
HDLB1005M121T1R2-LF	120	100	0.10	1200
HDLB1005M121T1R3-LF	120	100	0.10	1300
HDLB1005M121T1R5-LF	120	100	0.10	1500
HDLB1005M121T2R0-LF	120	100	0.10	2000
HDLB1005M151T1R3-LF	150	100	0.10	1300
HDLB1005M181T1R5-LF	180	100	0.10	1500
HDLB1005M221T1R0-LF	220	100	0.30	1000
HDLB1005M221T2R0-LF	220	100	0.30	2000
HDLB1005M301T1R0-LF	300	100	0.35	1000
HDLB1005M331T1R2-LF	330	100	0.35	1200
HDLB1005M601T0R3-LF	600	100	0.60	300
HDLB1005M601T0R5-LF	600	100	0.60	500
HDLB1005M102T0R5-LF	1000	100	0.80	500
HDLB1005M182T0R25-LF	1800	100	1.10	250



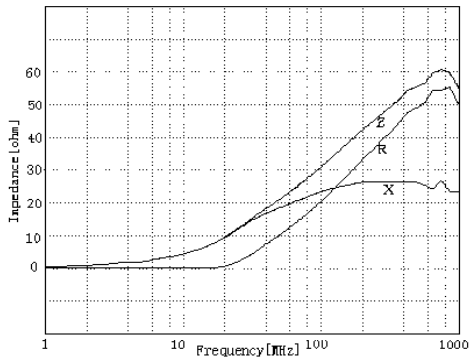
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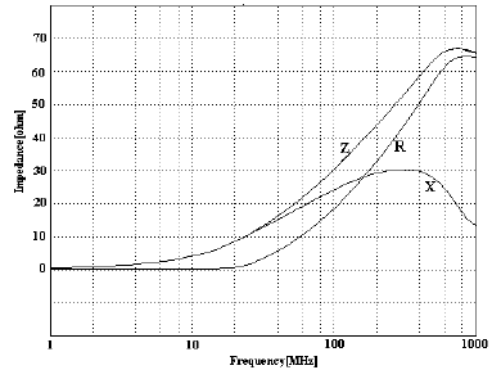
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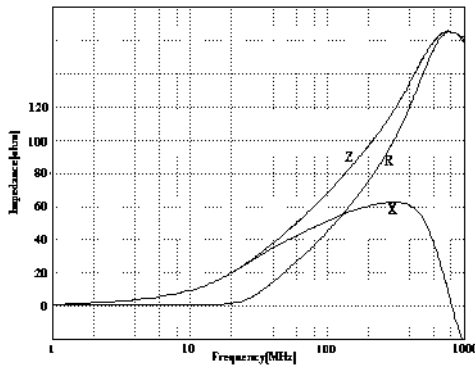
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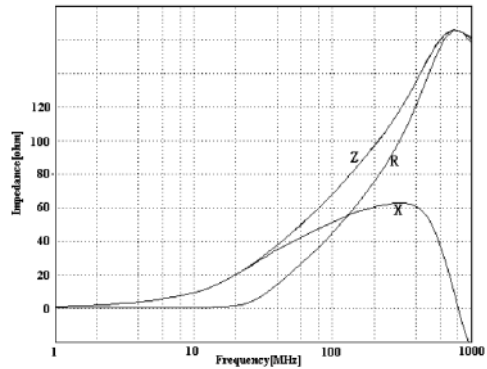
HDLB1005M310T1R5-LF



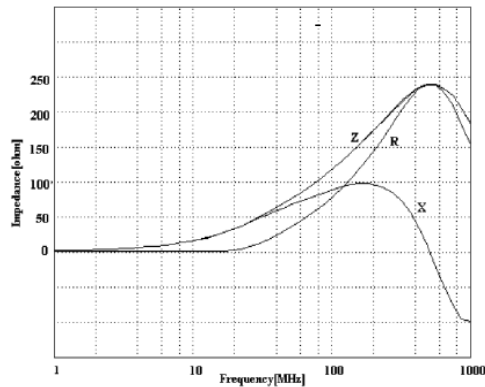
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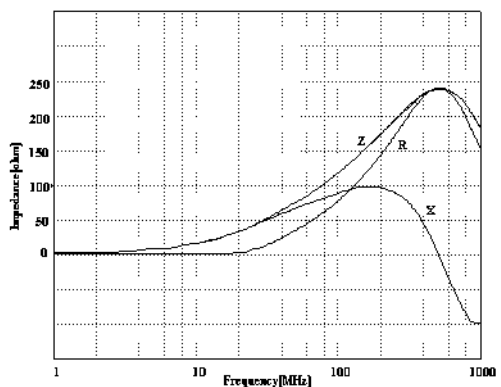
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HDLB1005M101T1R2-LF

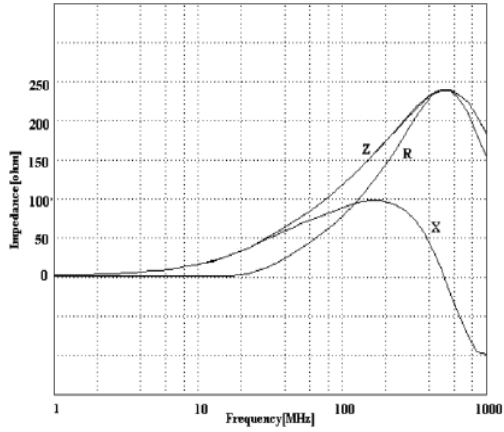


HDLB 1005M121T1R2-LF

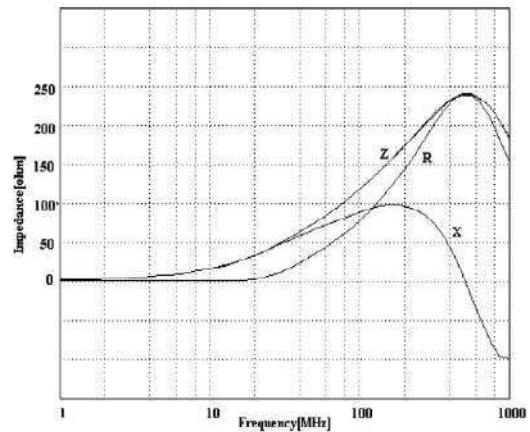




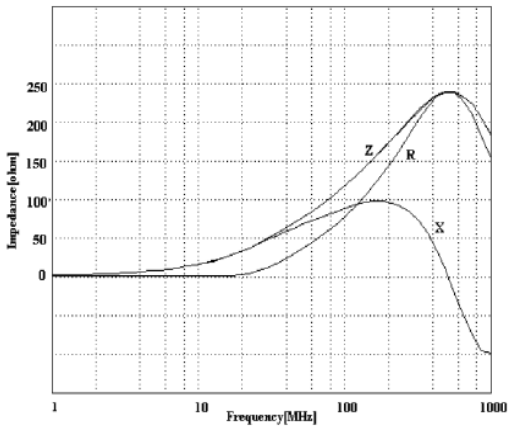
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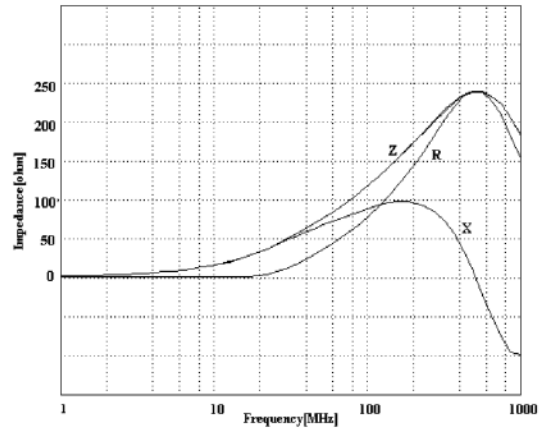
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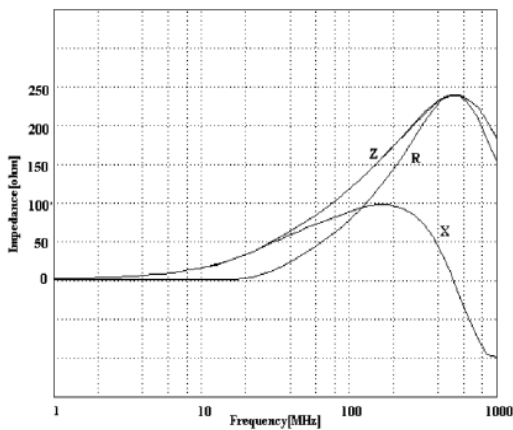
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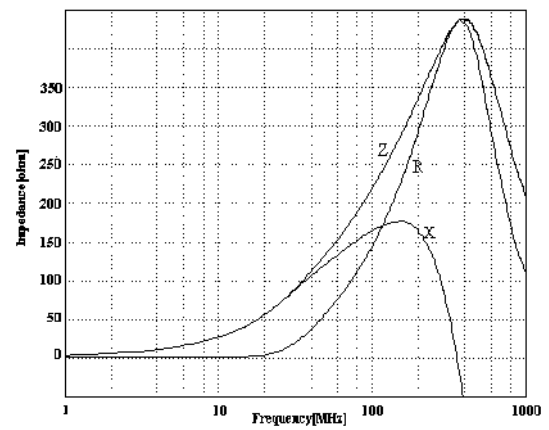
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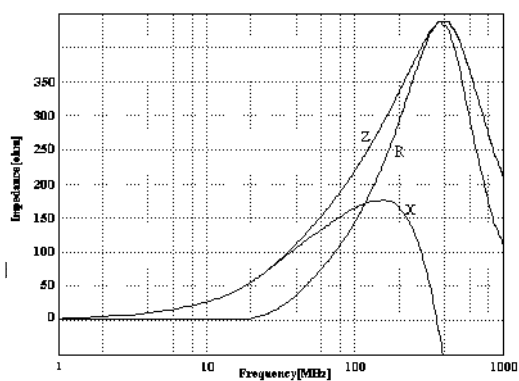
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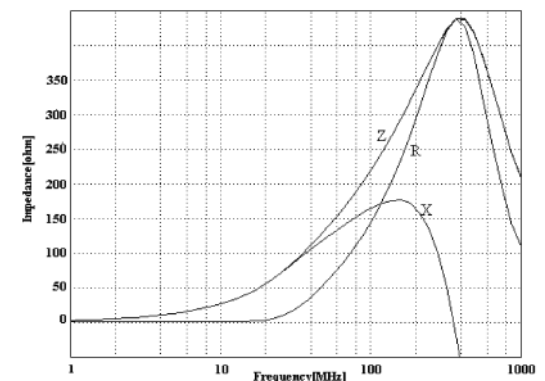
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HDLB1005M301T1R0-LF

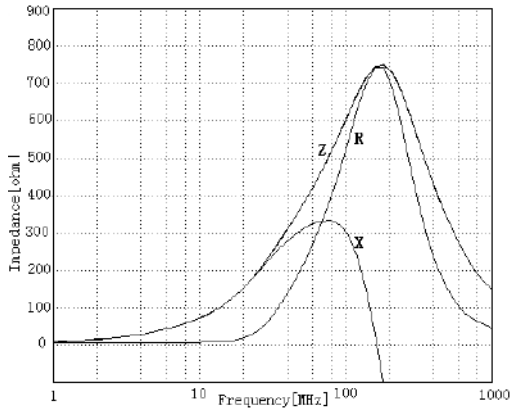


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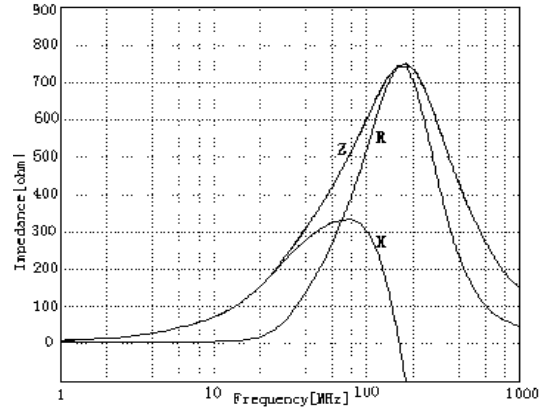




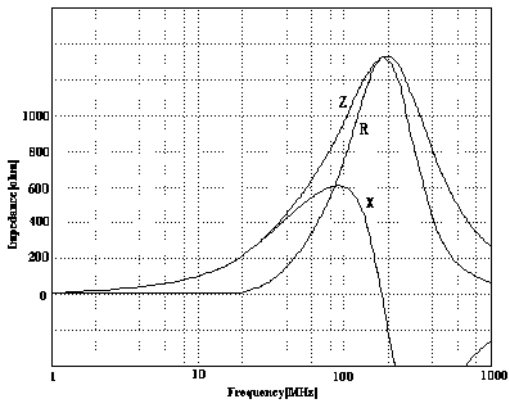
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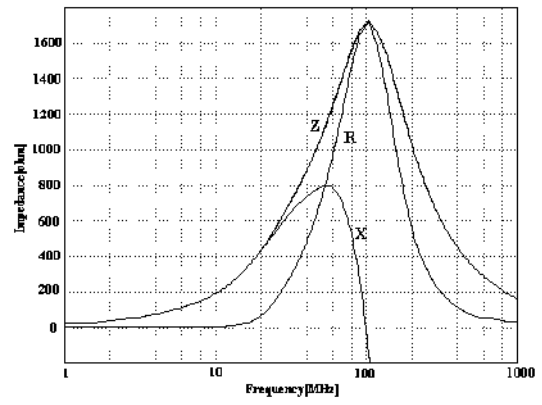
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HDLB1005M102T0R5-LF



HDLB1005M182T0R25-LF



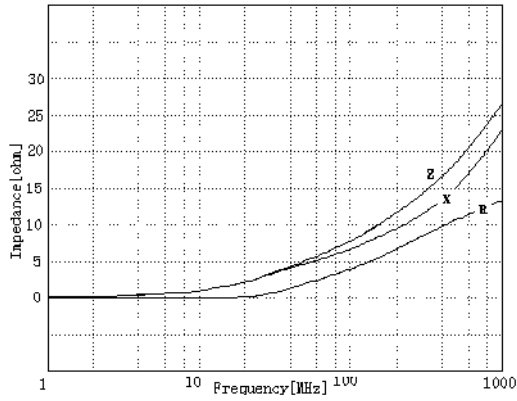


1608 Series

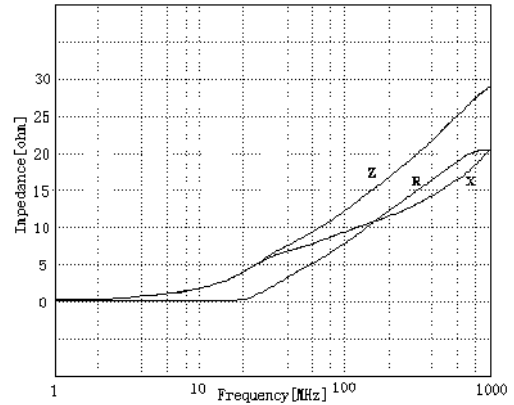
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HDLB1608M070T2R0-LF	7	100	0.03	2000
HDLB1608M110T2R0-LF	11	100	0.03	2000
HDLB1608M260T6R0-LF	26	100	0.025	6000
HDLB1608M300T3R0-LF	30	100	0.025	3000
HDLB1608M310T1R5-LF	31	100	0.05	1500
HDLB1608M600T1R5-LF	60	100	0.08	1500
HDLB1608M600T3R0-LF	60	100	0.07	3000
HDLB1608M700T4R0-LF	70	100	0.07	4000
HDLB1608M101T2R5-LF	100	100	0.08	2500
HDLB1608M101T3R0-LF	100	100	0.08	3000
HDLB1608M121T1R2-LF	120	100	0.10	1200
HDLB1608M121T2R0-LF	120	100	0.08	2000
HDLB1608M121T3R0-LF	120	100	0.08	3000
HDLB1608M221T1R0-LF	220	100	0.15	1000
HDLB1608M221T2R0-LF	220	100	0.10	2000
HDLB1608M301T1R0-LF	300	100	0.30	1000
HDLB1608M331T2R0-LF	330	100	0.30	2000
HDLB1608M471T1R5-LF	470	100	0.20	1500
HDLB1608M501T0R8-LF	500	100	0.30	800
HDLB1608M601T0R8-LF	600	100	0.35	800
HDLB1608M601T1R0-LF	600	100	0.35	1000
HDLB1608M601T1R5-LF	600	100	0.20	1500
HDLB1608M102T0R2-LF	1000	100	0.45	200
HDLB1608M102T0R6-LF	1000	100	0.45	600
HDLB1608M102T1R0-LF	1000	100	0.50	1000
HDLB1608M152T0R5-LF	1500	100	0.60	500
HDLB1608M252T0R1-LF	2500	100	1.00	100



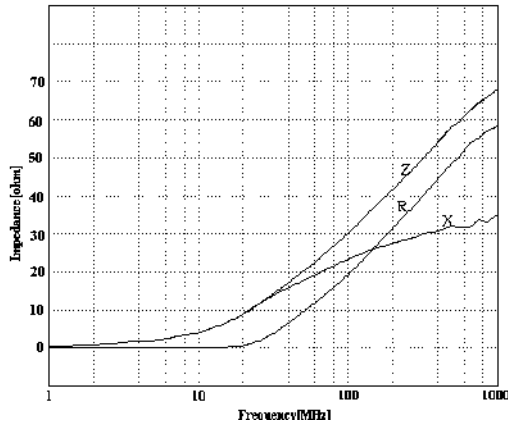
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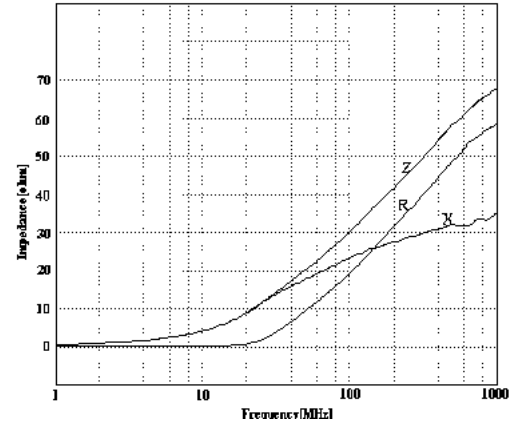
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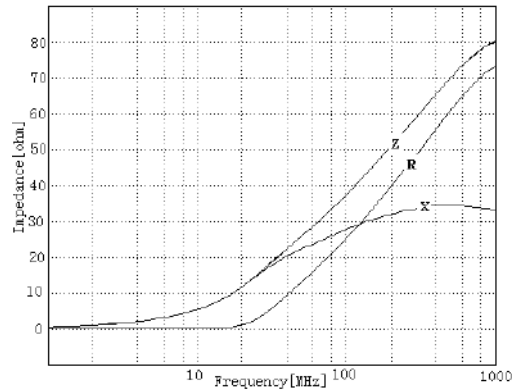
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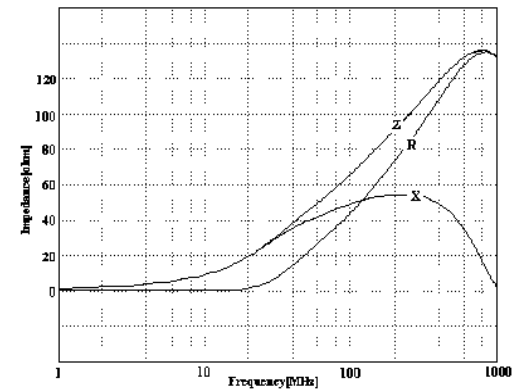
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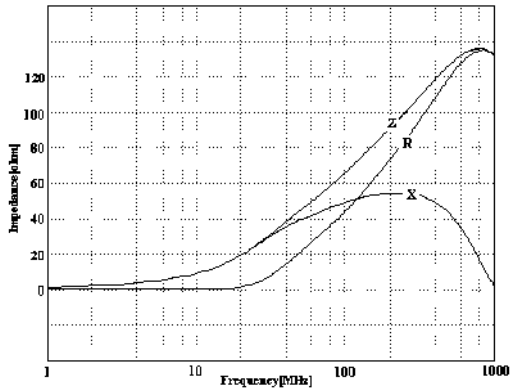
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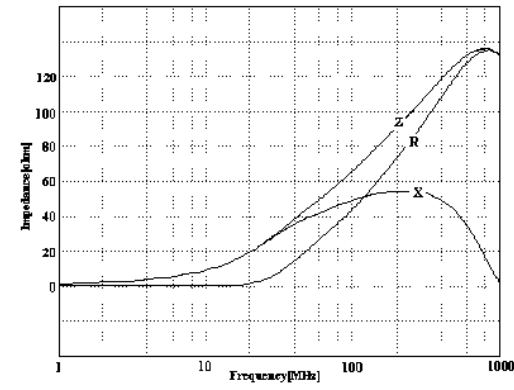
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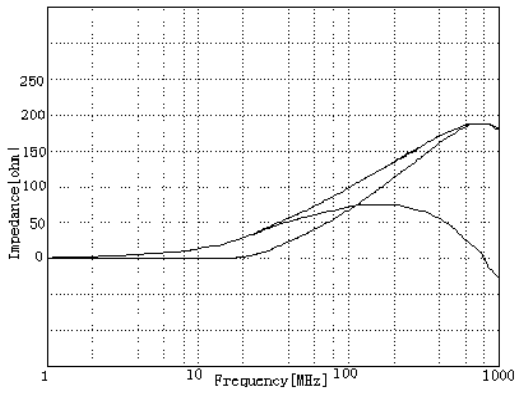
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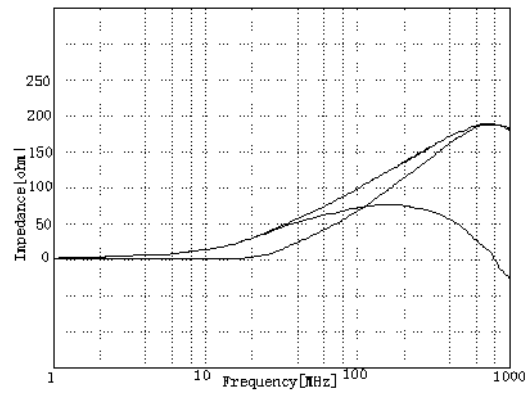
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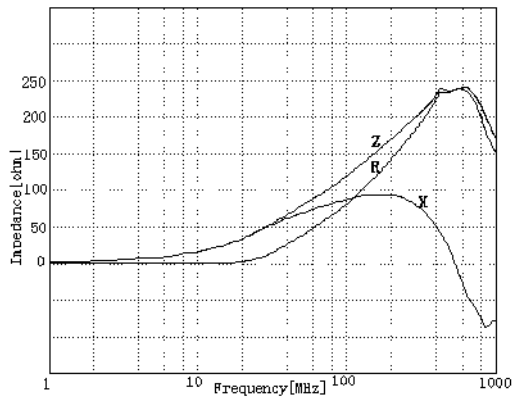
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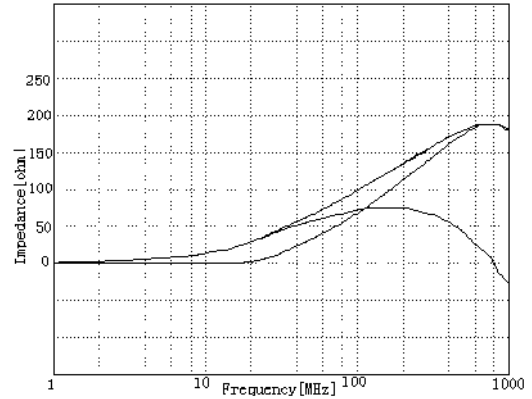
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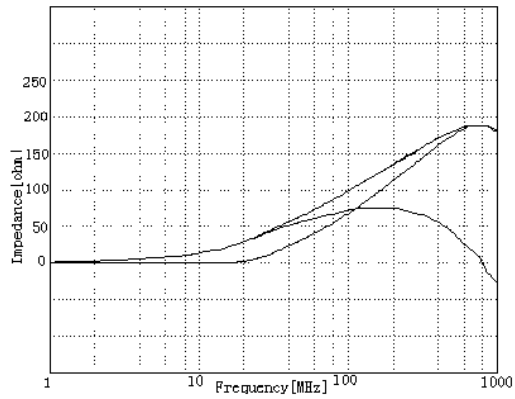
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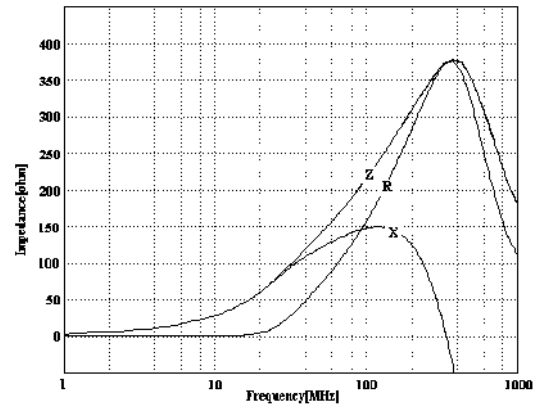
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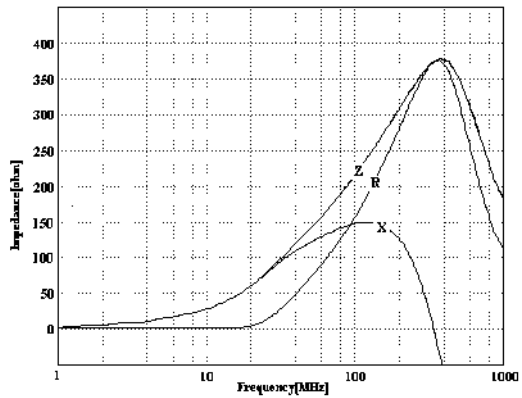
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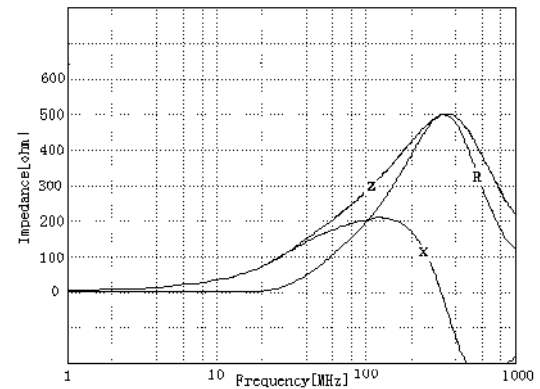
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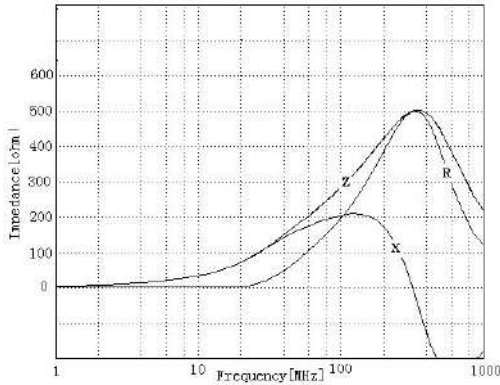
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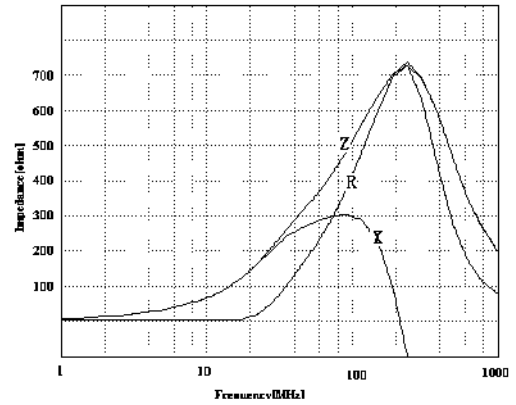
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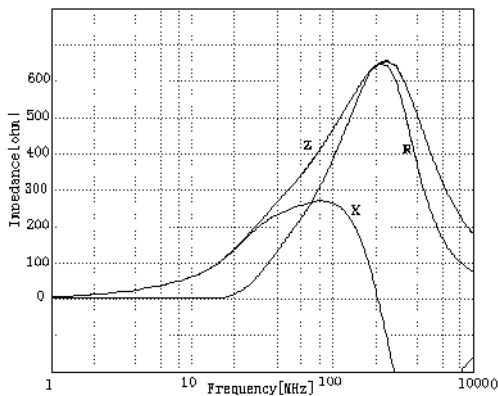
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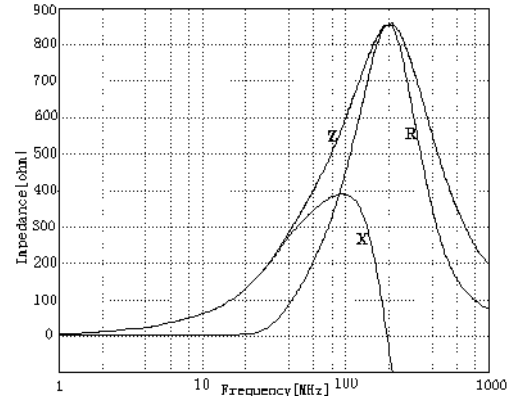
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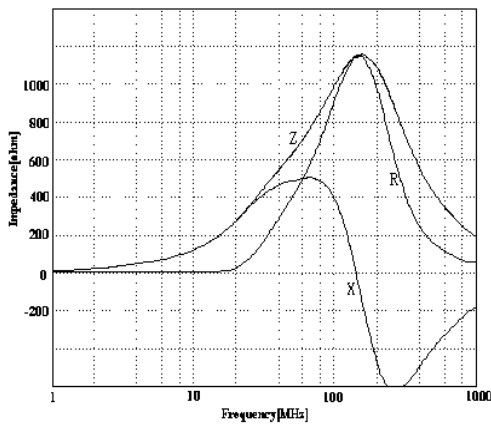
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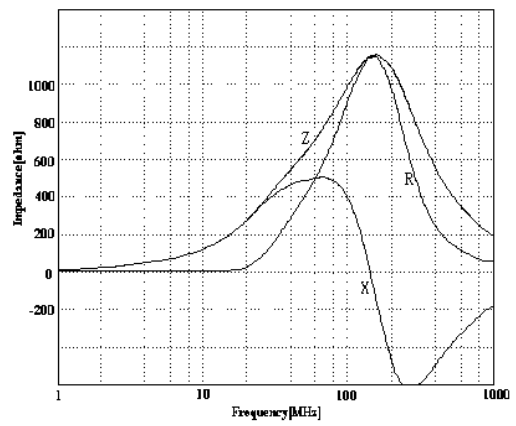
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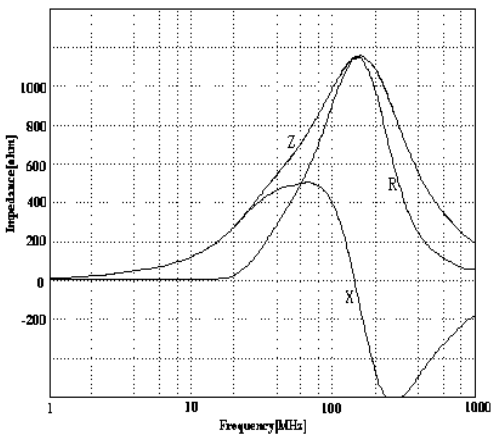
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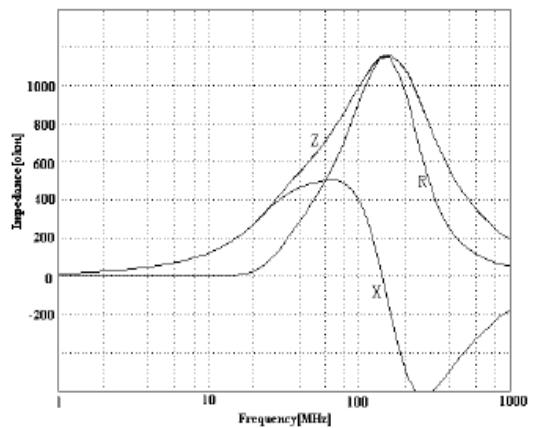
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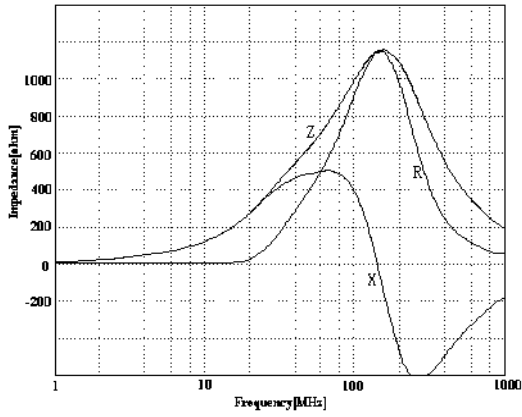


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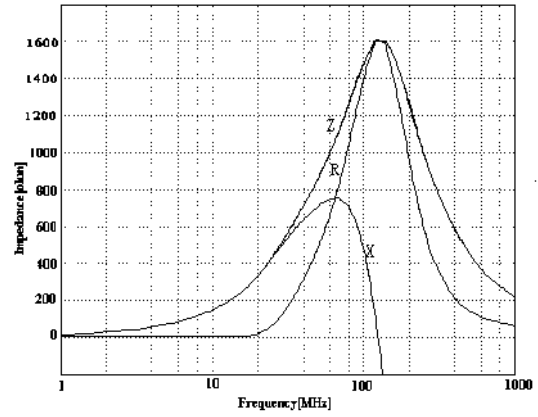




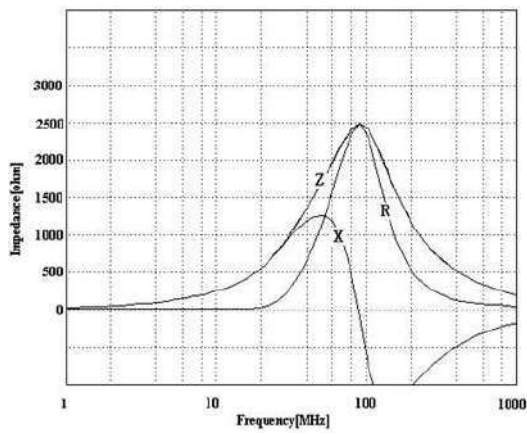
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HDLB1608M152T0R5-LF



HDLB1608M252T0R1-LF

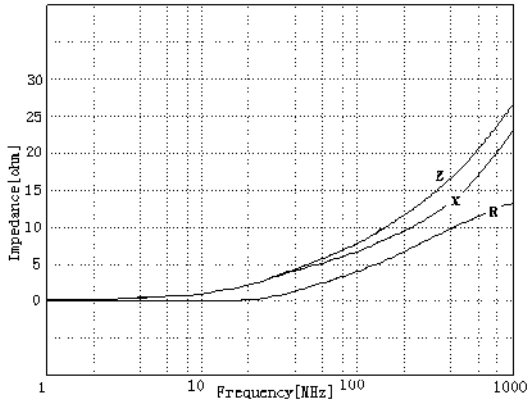




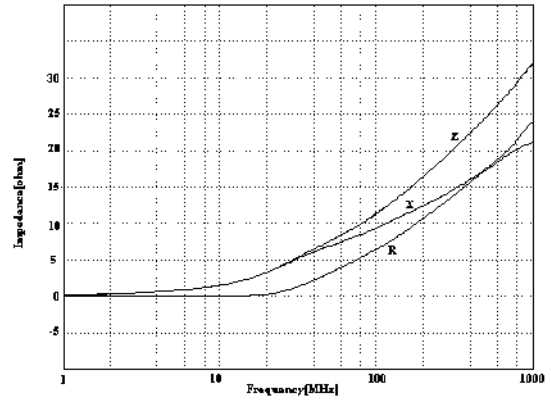
2012 Series

Part No.	Impedance (Ω) ± 25%	Z Test Freq. (MHz)	RDC (Ω) /max	Ir(mA) /max
HDLB2012M070T4R0-LF	7	100	0.02	4000
HDLB2012M110T2R0-LF	≤15	100	0.02	2000
HDLB2012M110T3R0-LF	11	100	0.02	3000
HDLB2012M190T4R0-LF	19	100	0.015	4000
HDLB2012M220T6R0-LF	22	100	0.01	6000
HDLB2012M300T4R0-LF	30	100	0.015	4000
HDLB2012M300T6R0-LF	30	100	0.015	6000
HDLB2012M310T3R0-LF	31	100	0.03	3000
HDLB2012M400T3R0-LF	40	100	0.03	3000
HDLB2012M600T3R0-LF	60	100	0.04	3000
HDLB2012M600T5R0-LF	60	100	0.05	5000
HDLB2012M101T2R0-LF	100	100	0.08	2000
HDLB2012E101T4R0-LF	100	100	0.025	4000
HDLB2012M121T2R0-LF	120	100	0.10	2000
HDLB2012M121T3R0-LF	120	100	0.05	3000
HDLB2012M121T4R0-LF	120	100	0.05	4000
HDLB2012E121T5R0-LF	120	100	0.025	5000
HDLB2012M221T2R0-LF	220	100	0.17	2000
HDLB2012M221T3R0-LF	220	100	0.17	3000
HDLB2012M301T1R5-LF	300	100	0.20	1500
HDLB2012M331T1R5-LF	330	100	0.20	1500
HDLB2012M331T2R5-LF	330	100	0.20	2500
HDLB2012M601T1R2-LF	600	100	0.25	1200
HDLB2012M601T2R0-LF	600	100	0.25	2000
HDLB2012M102T1R0-LF	1000	100	0.30	1000
HDLB2012M102T1R5-LF	1000	100	0.30	1500
HDLB2012M222T0R2-LF	2200	50	0.50	200

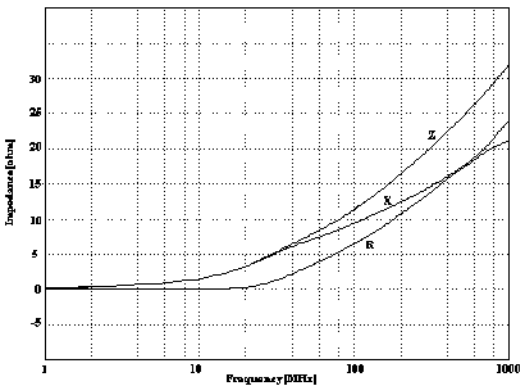
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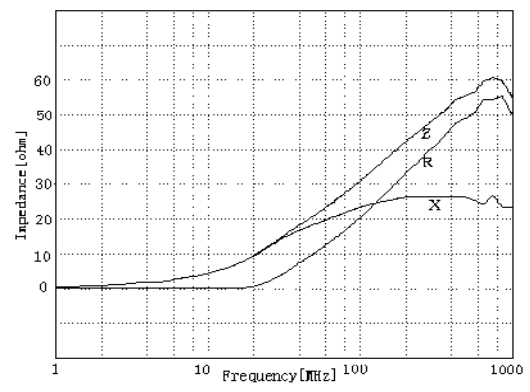
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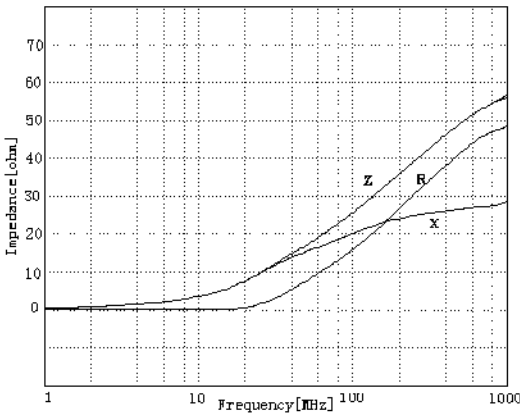
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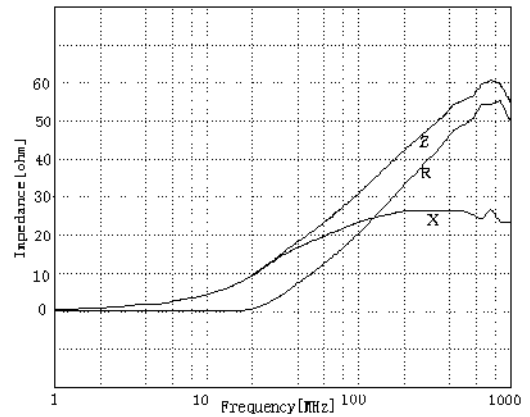
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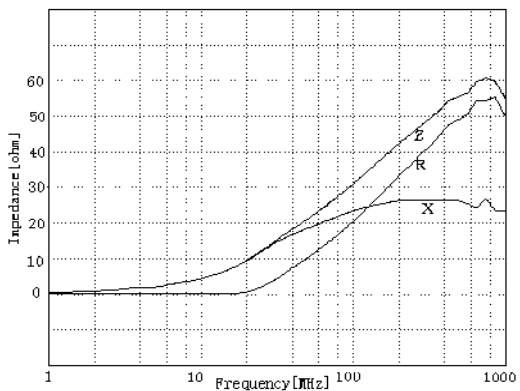
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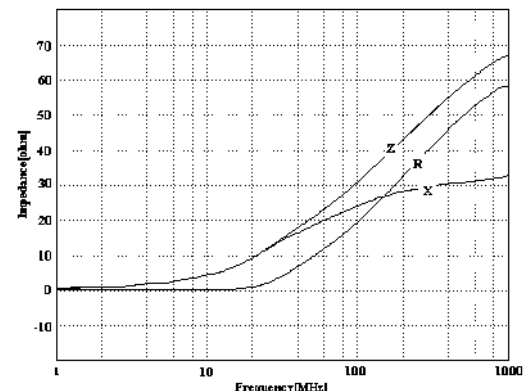
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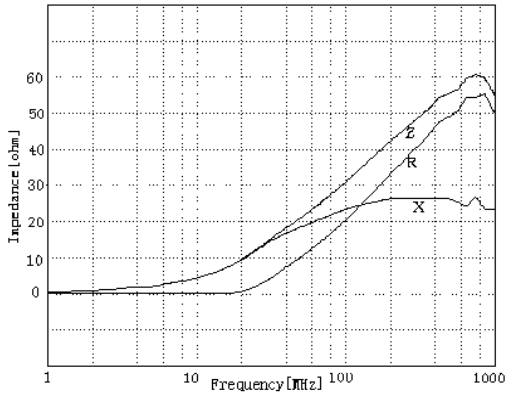


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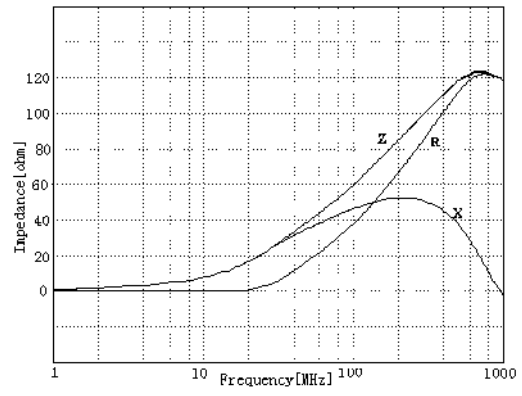




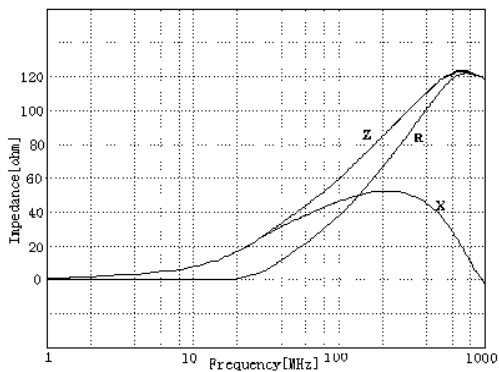
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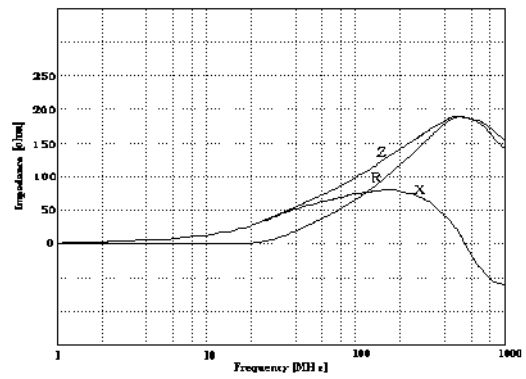
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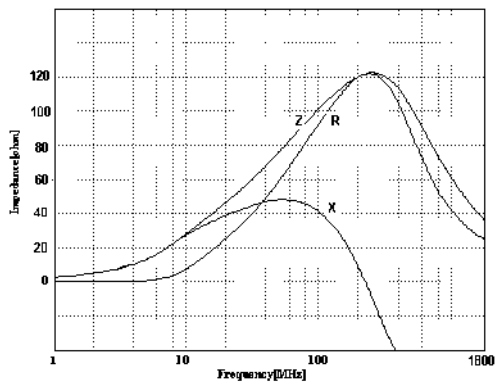
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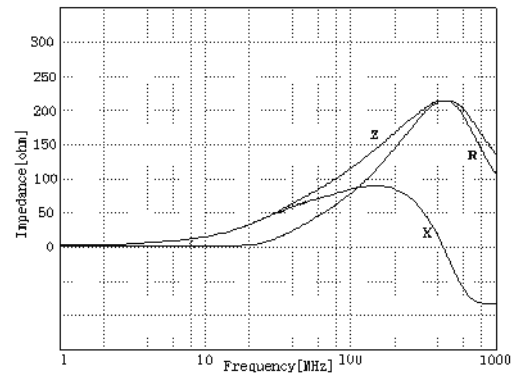
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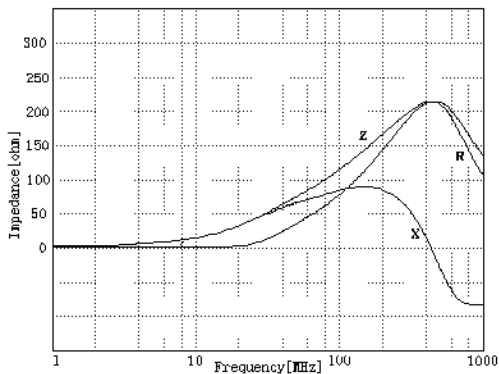
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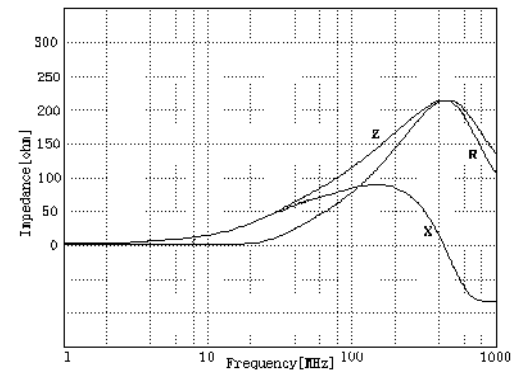
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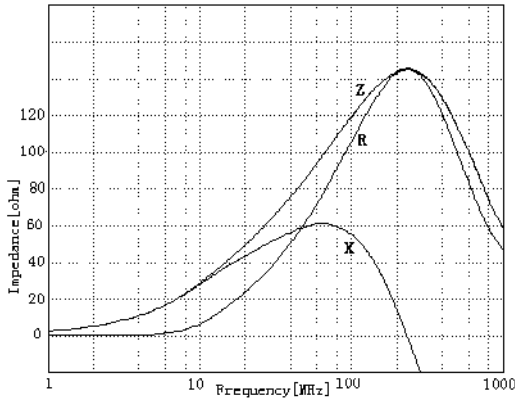
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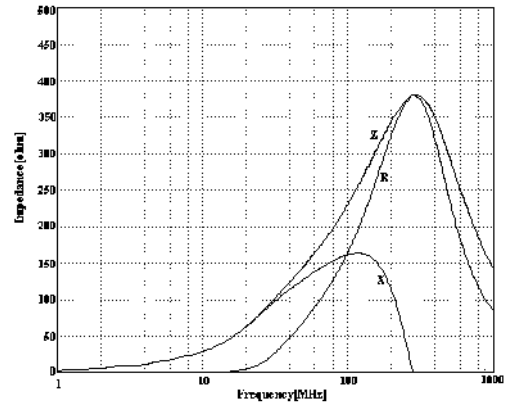
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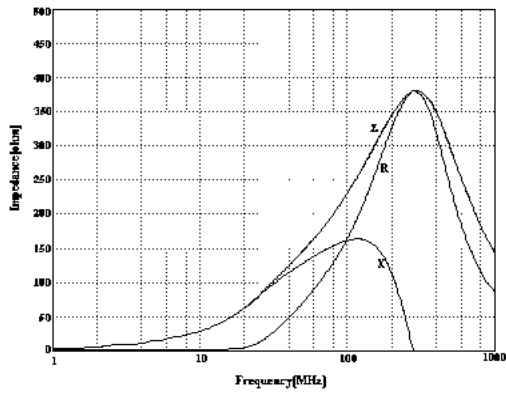
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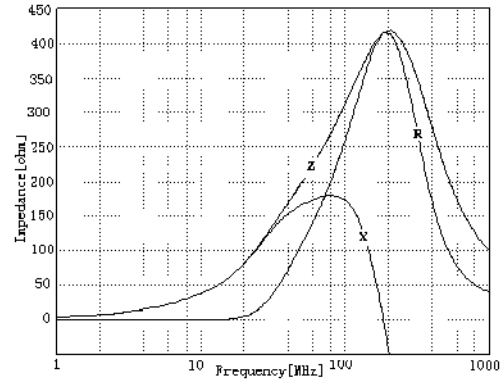
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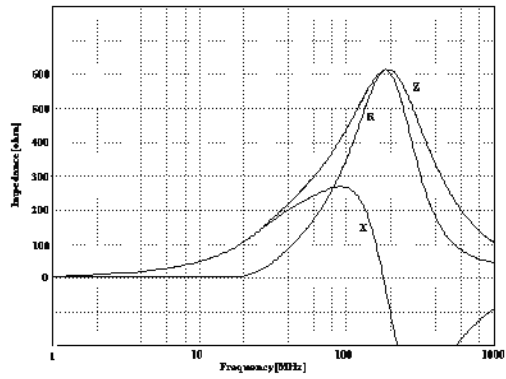
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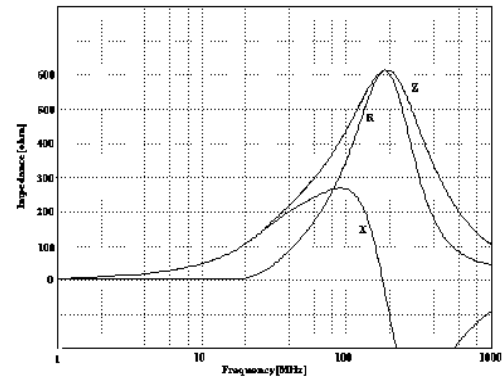
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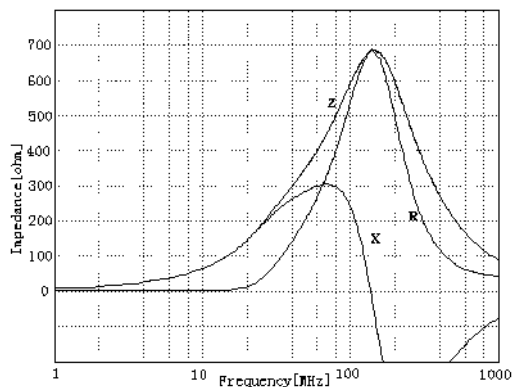
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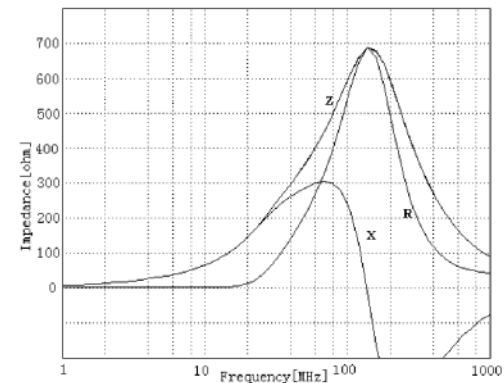
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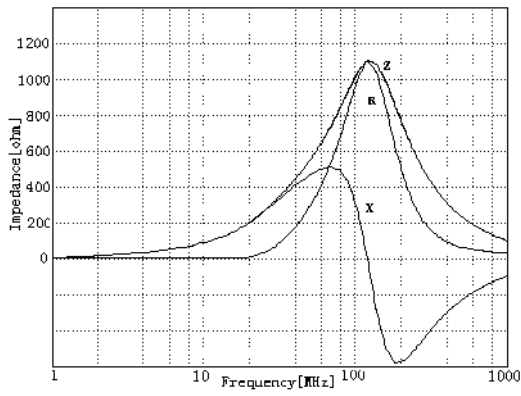


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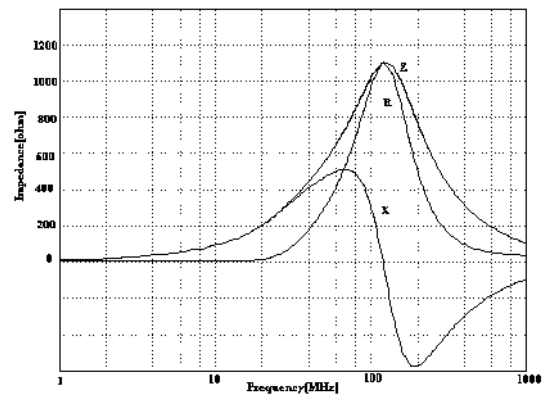




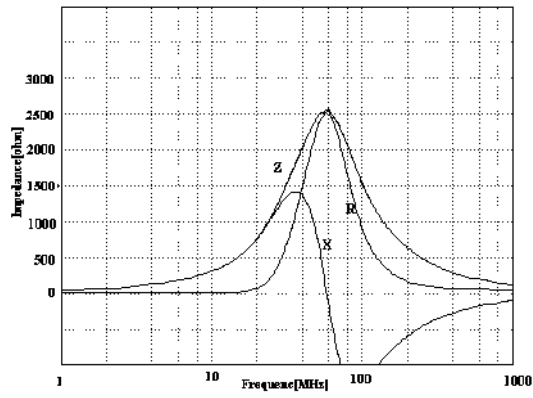
HDLB2012M102T1R0-LF



HDLB 2012M102T1R5-LF



HDLB2012M222T0R2-LF

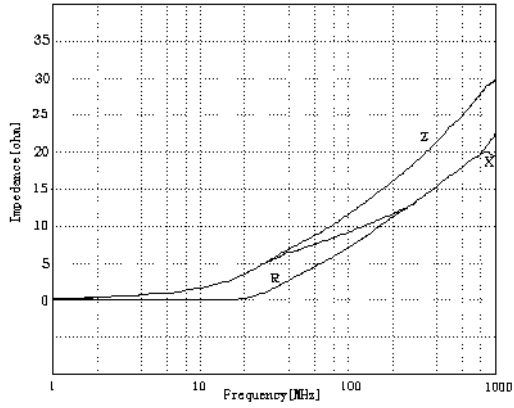


3216 Series

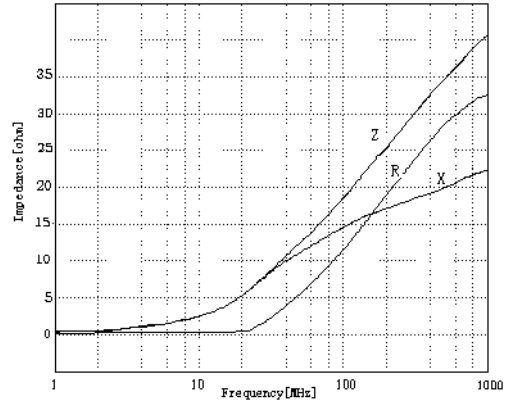
Part No.	Impedance (Ω) ±25%	Z Test Freq. (MHz)	RDC(Ω) /max	Ir(mA) /max
HDLB3216M110T4R0-LF	11	100	0.02	4000
HDLB3216M190T4R0-LF	19	100	0.02	4000
HDLB3216M260T4R0-LF	26	100	0.02	4000
HDLB3216M310T4R0-LF	31	100	0.02	4000
HDLB3216M310T6R0-LF	31	100	0.02	6000
HDLB3216M330T6R0-LF	33	100	0.02	6000
HDLB3216M500T6R0-LF	50	100	0.025	6000
HDLB3216M600T4R0-LF	60	100	0.025	4000
HDLB3216M700T3R0-LF	70	100	0.05	3000
HDLB3216M121T2R0-LF	120	100	0.035	2000
HDLB3216M121T3R0-LF	120	100	0.05	3000
HDLB3216M181T2R5-LF	180	100	0.10	2500
HDLB3216M221T2R5-LF	220	100	0.10	2500
HDLB3216M301T2R2-LF	300	100	0.15	2200
HDLB3216M501T3R0-LF	500	100	0.06	3000
HDLB3216M601T2R0-LF	600	100	0.20	2000
HDLB3216M102T1R5-LF	1000	100	0.30	1500
HDLB3216M102T2R0-LF	1000	100	0.30	2000
HDLB3216M152T1R0-LF	1500	50	0.35	1000
HDLB3216M202T0R7-LF	2000	50	0.45	700



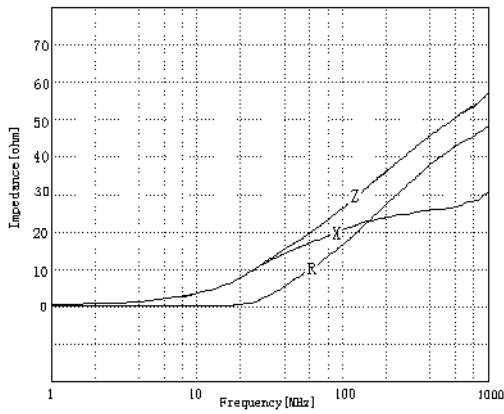
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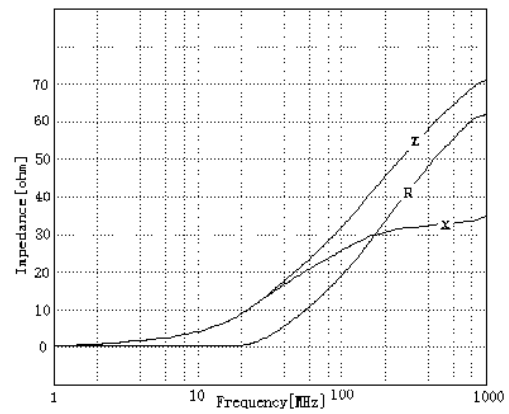
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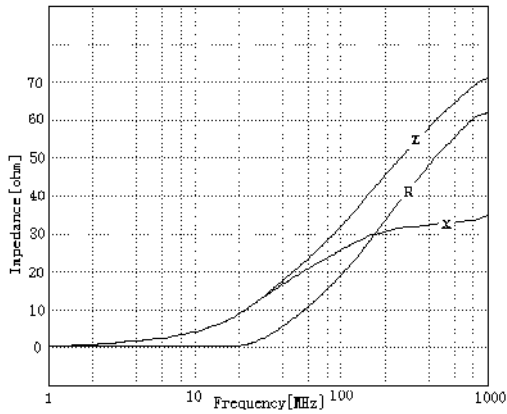
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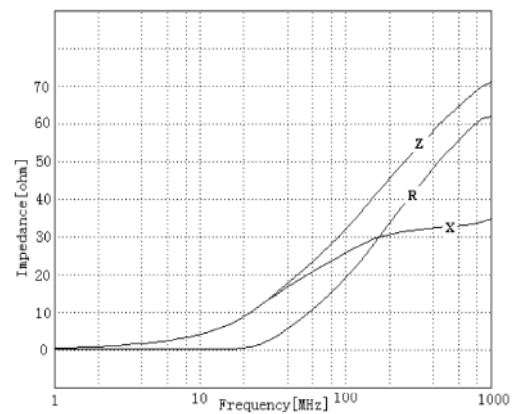
HDLB3216 M310T4R0-LF



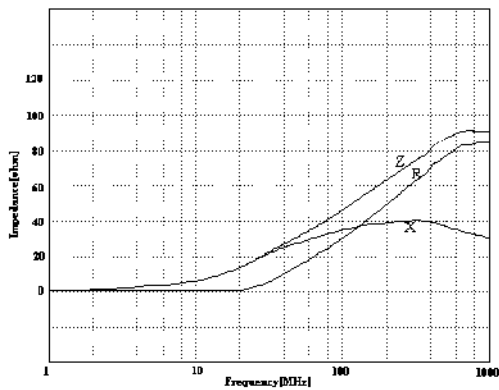
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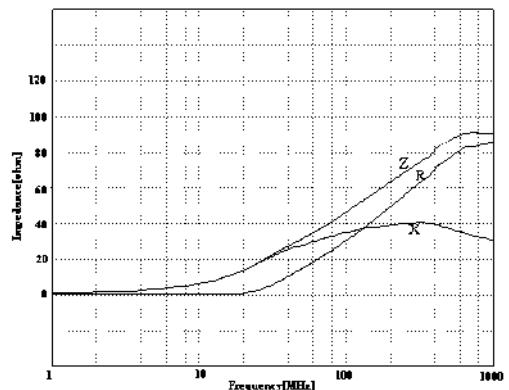
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HDLB3216 M500T6R0-LF

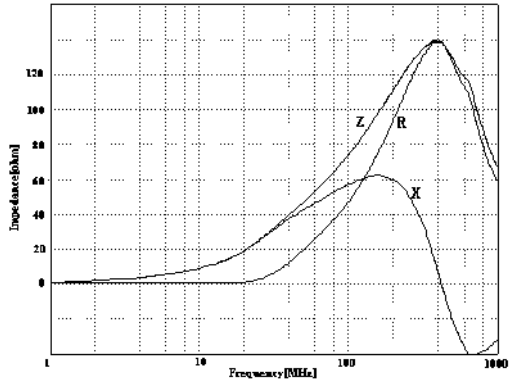


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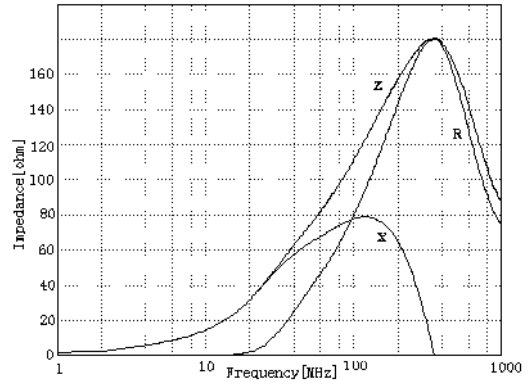




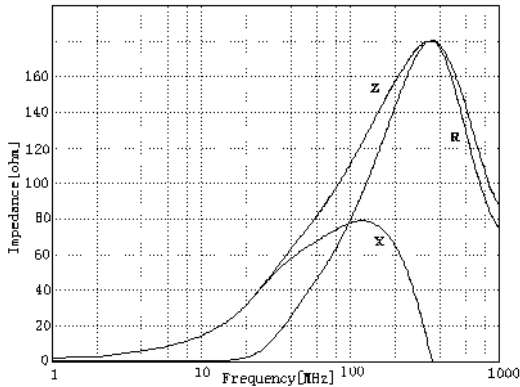
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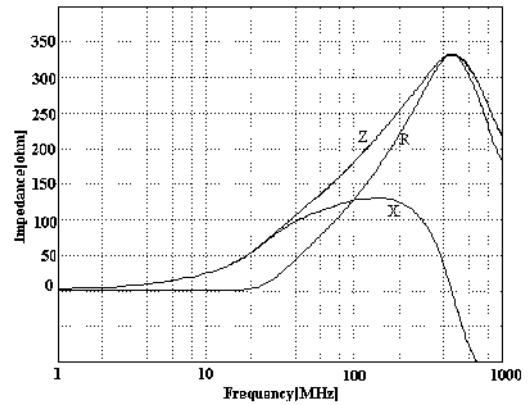
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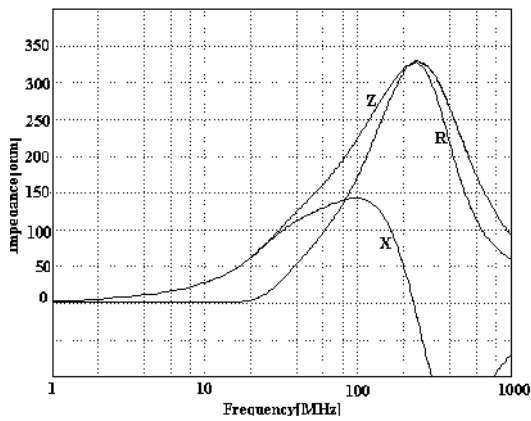
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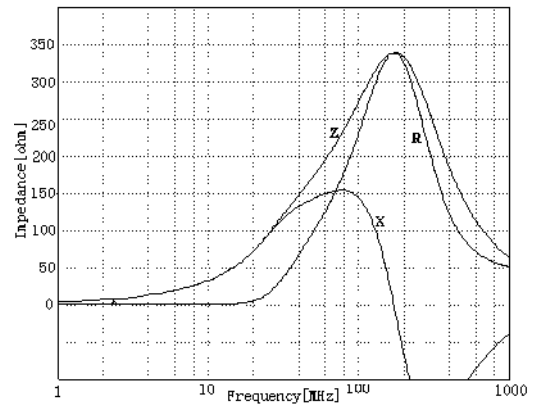
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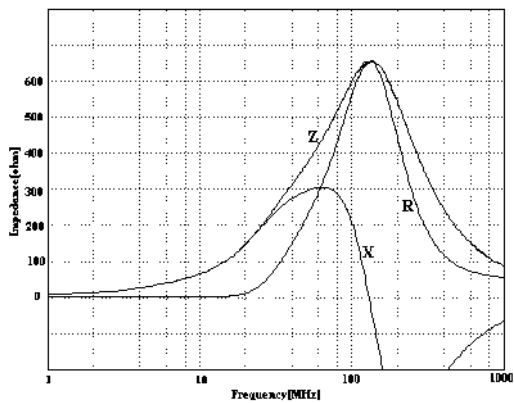
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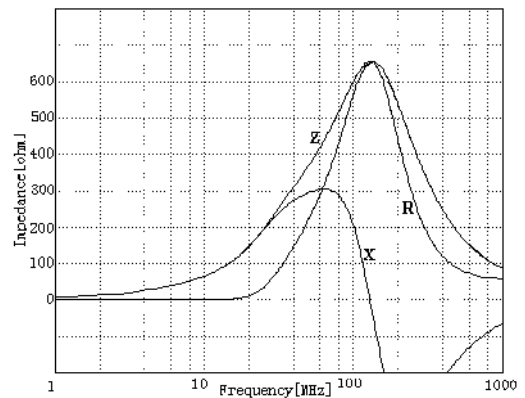
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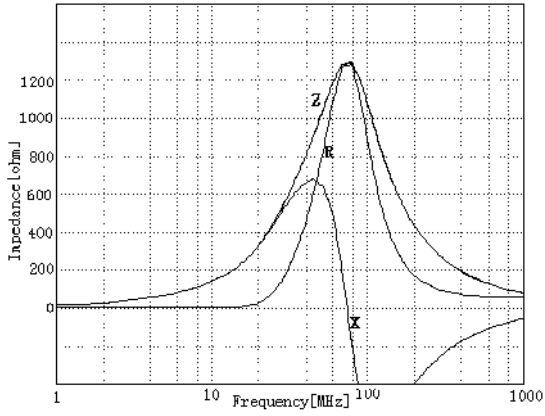
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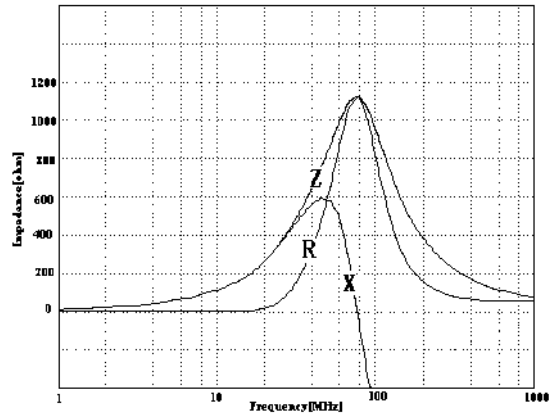
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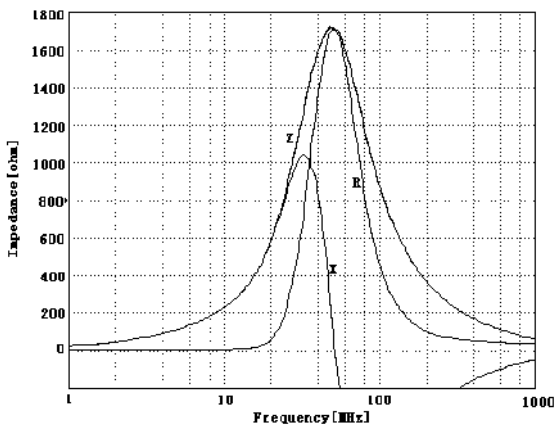
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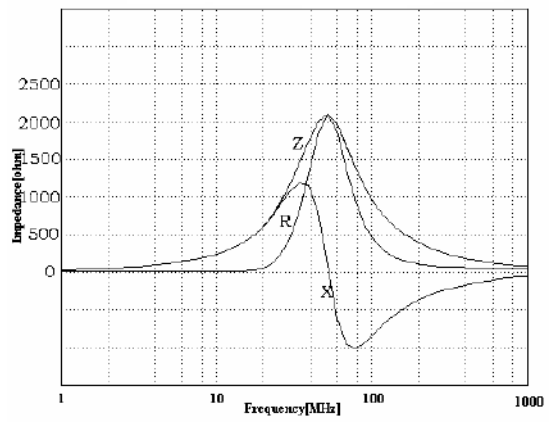
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HDLB3216M202T0R7-LF



6 Electrical Performance

6.1 Impedance

Impedance shall meet item 5 when measured on the condition of Table 1.

Table 1

Measuring Equipment	Impedance analyzer HP4291 or equivalent
Measuring Frequency	(see item 5)
Measuring signal level	50mV

6.2 DC Resistance

D.C Resistance shall meet item 5 when measured on the condition of Table 2.

Table 2

Measuring Equipment	LCR Meter HP4263A or equivalent
---------------------	---------------------------------

6.3 Rated current

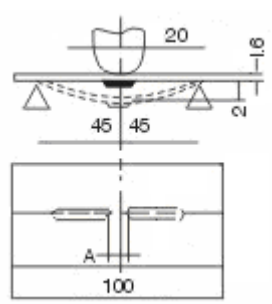
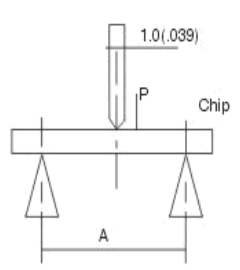
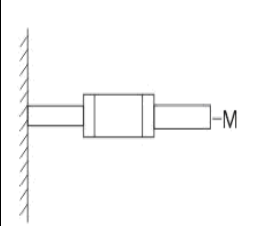
Chip surface temperature rise just 40°C against chip surface temperature when the allowable current (which is mentioned in item 5) is applied.

Table 3

Measuring Equipment	Electric Power Supplier, Electric Current Meter, Thermometer
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7 Reliable Performance

NO.	Item	Specifications	Test Methods															
1	Solder-Ability	More than 90% of termination should be covered with new solder.	Solder : Sn Temperature : 255°C+5°C/-0°C Flux : rosin Duration : 3.5±0.5s															
2	Leaching Resistance	More than 75% of termination Should be covered with new solder.	Solder : Sn Temperature : 270°C+2°C/-0°C Flux : rosin Duration : 10±0.5s															
3	Bending Strength	No mechanical damage should be noticed	When the board curve to 2mm(0.079 inches) <table border="1" style="display: inline-table; margin-right: 20px;"> <thead> <tr> <th>Size</th> <th>A(mm)</th> </tr> </thead> <tbody> <tr> <td>1005</td> <td>0.5</td> </tr> <tr> <td>1608</td> <td>0.7</td> </tr> <tr> <td>2012</td> <td>1.0</td> </tr> <tr> <td>3216</td> <td>1.0</td> </tr> </tbody> </table> 	Size	A(mm)	1005	0.5	1608	0.7	2012	1.0	3216	1.0					
Size	A(mm)																	
1005	0.5																	
1608	0.7																	
2012	1.0																	
3216	1.0																	
4	Body Strength	No mechanical damage should be noticed	Applied specified pull strength in axial direction <table border="1" style="display: inline-table; margin-right: 20px;"> <thead> <tr> <th>Size</th> <th>A/mm</th> <th>P/N</th> </tr> </thead> <tbody> <tr> <td>1005</td> <td>0.7</td> <td>4.9</td> </tr> <tr> <td>1608</td> <td>1.0</td> <td>4.9</td> </tr> <tr> <td>2012</td> <td>1.4</td> <td>9.8</td> </tr> <tr> <td>3216</td> <td>1.4</td> <td>9.8</td> </tr> </tbody> </table> 	Size	A/mm	P/N	1005	0.7	4.9	1608	1.0	4.9	2012	1.4	9.8	3216	1.4	9.8
Size	A/mm	P/N																
1005	0.7	4.9																
1608	1.0	4.9																
2012	1.4	9.8																
3216	1.4	9.8																
5	Terminal Strength	The terminal and body should be no damage	Applied specified pull strength in axial <table border="1" style="display: inline-table; margin-right: 20px;"> <thead> <tr> <th>Size</th> <th>Pull Strength</th> <th>Time (s)</th> </tr> </thead> <tbody> <tr> <td>1005</td> <td>3 N</td> <td>5±1</td> </tr> <tr> <td>1608</td> <td>5 N</td> <td>5±1</td> </tr> <tr> <td>2012</td> <td>10 N</td> <td>5±1</td> </tr> <tr> <td>3216</td> <td>10 N</td> <td>5±1</td> </tr> </tbody> </table> 	Size	Pull Strength	Time (s)	1005	3 N	5±1	1608	5 N	5±1	2012	10 N	5±1	3216	10 N	5±1
Size	Pull Strength	Time (s)																
1005	3 N	5±1																
1608	5 N	5±1																
2012	10 N	5±1																
3216	10 N	5±1																

NO.	Item	Specifications	Test Methods
6	Drop	1.No mechanical damage shall be noticed 2.Impedance shall be within $\pm 20\%$ of the initial value	Drop 10 times on a concrete floor from a height of 1m.
7	Vibration		Frequency : 10 to 55Hz Amplitude : 1.52mm Direction and time : X, Y and Z directions for 2 hours each.
8	Humidity resistance		a. Test condition Temp. : 60 ± 2 °C Humidity : 90%~95% Test time : 1000 h b. Measurement method : The component should be stabilized at normal condition for 24 hours before test.
9	High temperature resistance		a. Test condition Applied rated current Temp. : 125 ± 2 °C Test time : 1000 h b. Measurement method : The component should be stabilized at normal condition for 24 hours before test.
10	Low temperature resistance		a. Test condition Temp. : -55 ± 2 °C Test time : 1000 h b. Measurement method : The component should be stabilized at normal condition for 24 hours before test.
11	Thermal shock		a. Test condition 1) Temp. : -55 °C, time : 30 ± 3 min 2) Temp. : $+125$ °C, time : 30 ± 3 min 100 cycles b. Measurement method : The component should be stabilized at normal condition for 24 hours before test.

8 Recommended Soldering Conditions

Product can be applied to flow and reflow soldering.

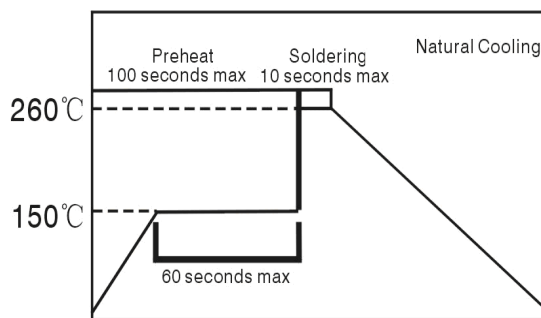
(1) Flux, Solder

- ① Use rosin-based flux. Don't use highly acidic flux with halide content exceeding 0.2wt% (chlorine conversion value).
- ② Use Sn solder.

(2) Flow soldering conditions

- ① Pre-heating should be in such a way that the temperature difference between solder and product surface is limited to 150°C max. Cooling into solvent after soldering also should be in such a way that temperature difference is limited to 100°C max. Unwrought pre-heating may cause cracks on the product, resulting in the deterioration of products quality.

- ② Standard soldering profile.



Pre-heating	150°C, 1 minute min
Peak	260°C, 10 seconds max

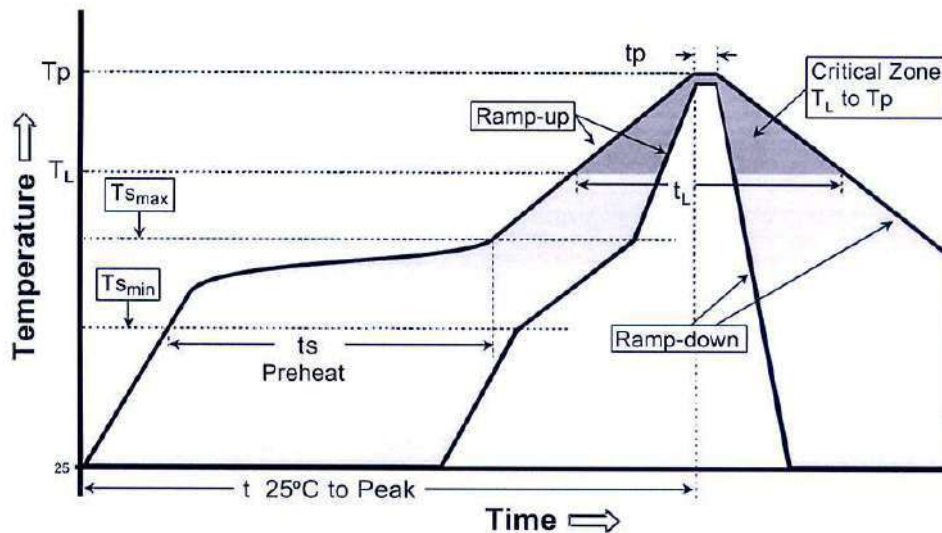
(3) Reflow soldering conditions

Profile Feature	Lead-Free Assembly
Average Ramp-Up Rate (T _{smax} to T _p)	3°C /second max.
Preheat <ul style="list-style-type: none"> - Temperature Min (T_{smin}) - Temperature Max (T_{smax}) - Time (t_{smin} to t_{smax}) min to t_{smax}) 	150 °C 200 °C 60-180 seconds

Profile Feature	Lead-Free Assembly
Time maintained above: Temperature (TL) Time (tL)	217 °C 60-150 seconds
Peak/Classification Temperature (Tp) Peak/Classification Time (Tp)	260 °C 3-4 seconds
Time within 5 °C of actual Peak Temperature (tp)	20-40 seconds
Ramp-Down Rate	6°C/second max.
Time 25 °C to Peak Temperature	8 minutes max.

Note 1: All temperatures refer to topside of the package, measured on the package body surface.

Standard soldering profile



(4) Reworking with soldering iron

The following conditions must be strictly followed when using a soldering iron.

Pre-heating	150°C, 1 minute
Tip temperature	350°C max
Soldering iron output	80w max
End of soldering iron	φ 1mm max
Soldering time	3 seconds max



9 Cleaning Conditions

Products shall be cleaned on the following conditions.

(1) Cleaning temperature shall be limited to 60°C max.(40°C max for fluoride and alcohol type cleaner.)

(2) Ultrasonic cleaning shall comply with the following conditions with avoiding the resonance phenomenon at the mounted products and P.C.B.

Power : 20W/t max

Frequency: 40 kHz

Time : 5 minutes max

(3) Cleaner

a) Alternative cleaner

Isopropyl alcohol (IPA) HCFC -225

b) Aqueous agent

Surface Active Agent Type (CLEANTHROUGH 750H)

Hydrocarbon Type (TECHNOCLEANER 335)

Higher Alcohol Type (PINE ALPHA ST -100S)

Alkali Saponification Type (*AQUACLEANER 240)

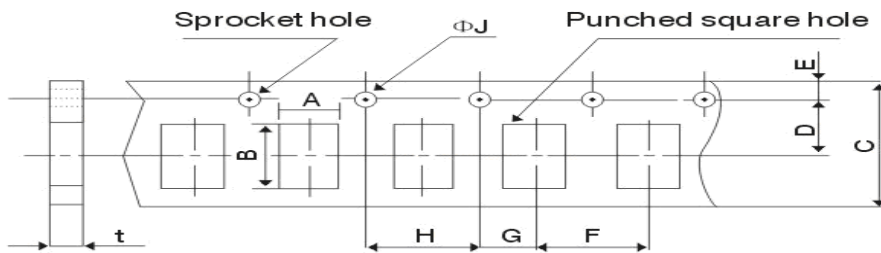
(4) There shall be no residual flux and residual cleaner after cleaning. In the case of using aqueous agent, products shall be dried completely after rinse with de-ionized water in order to remove the cleaner.

(5) Other cleaning Please contact us.

10 Packaging

(1) Dimensions of Tape:

Paper / Embossed carrier tape:

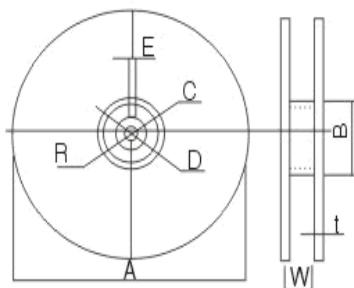


Type	3216		2012		1608	1005	0603
T*	1.1±0.3		0.85±0.2	1.25±0.2	0.8±0.15	0.5±0.15	0.3±0.05
	Paper carrier tape	Embossed carrier tape	Paper carrier tape	Embossed carrier tape	Paper carrier tape	Paper carrier tape	Paper carrier tape
A	2.0±0.2	2.0±0.2	1.5±0.15	1.5±0.15	1.05±0.15	0.65±0.10	0.4±0.05
B	3.6±0.2	3.6±0.2	2.5±0.2	2.5±0.2	1.9±0.15	1.15±0.10	0.7±0.05
C	8.0±0.3	8.0±0.3	8.0±0.3	8.0±0.3	8.0±0.3	8.0±0.3	8.0±0.3
D	3.5±0.05	3.5±0.05	3.5±0.05	3.5±0.05	3.5±0.05	3.5±0.05	3.5±0.05
E	1.75±0.1	1.75±0.1	1.75±0.1	1.75±0.1	1.75±0.1	1.75±0.1	1.75±0.1
F	4.0±0.1	4.0±0.1	4.0±0.1	4.0±0.1	4.0±0.1	2.0±0.05	2.0±0.05
G	2.0±0.05	2.0±0.05	2.0±0.05	2.0±0.05	2.0±0.05	2.0±0.05	2.0±0.05
H	4.0±0.1	4.0±0.1	4.0±0.1	4.0±0.1	4.0±0.1	4.0±0.1	4.0±0.1
ΦJ	1.5+0.1/-0	1.5+0.1/-0	1.5+0.1/-0	1.5+0.1/-0	1.5+0.1/-0	1.5+0.1/-0	1.5+0.1/-0
t(max)	1.1±0.05	2.0±0.05	1.1±0.05	1.0±0.05	1.0±0.05	0.8±0.05	0.55±0.05

T*: Product thickness

(2) Dimensions of Reel

Unit: mm



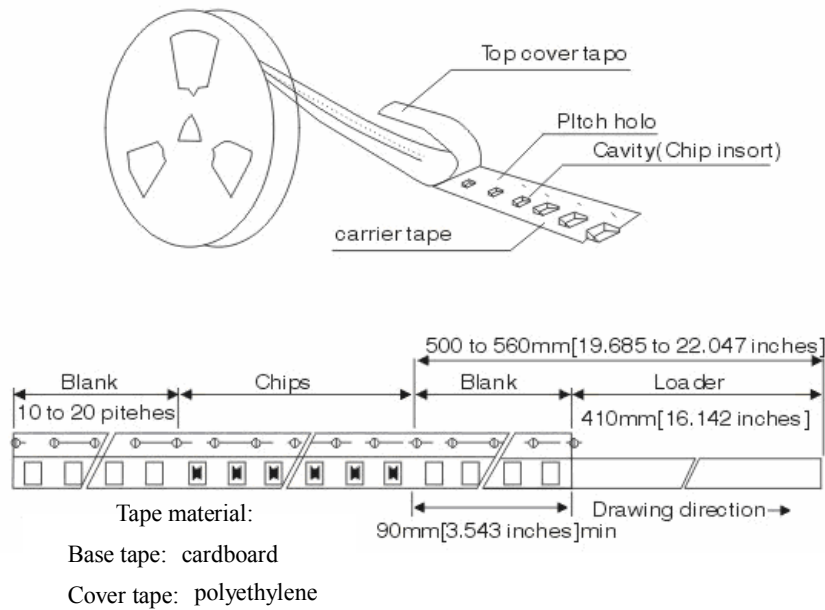
Reel material: PS (Polystyrene)

A	178±2
B	60±2
C	13.0±0.5
D	21.0±0.8
E	2.0±0.5
W	10.0±1.15
t	1.2±0.2
R	1.0±0.25

(3) Pulling strength of tapes

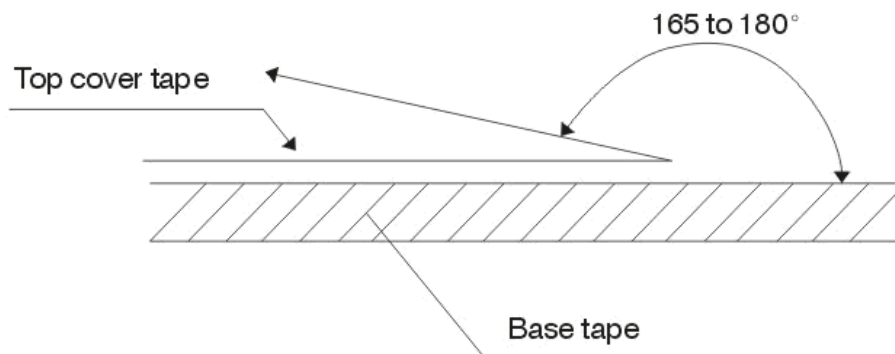
Carrier tape	10N or more (1kgf or more)
Cover tape	5N or more (0.5kgf or more)

(4) Taping figure and drawing direction



(5) Peeling strength of cover tape

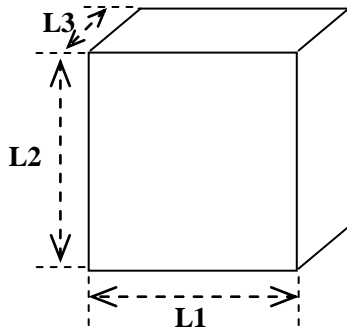
Cover tape	0.3~0.7N (30gf~70gf)
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Test condition:

- 1) peel angle: 165°~180° vs. carrier tape.
- 2) peel speed: 300 mm/min±10%.

(6) Box and case dimensions



Unit: mm

Type	L1	L2	L3
Box	180±2	180±2	75±1
Box	180±2	180±2	120±2
Case	400±2	400±2	200±2

A 6 reels in a box.

B 10 boxes in a case.

(7) Packaging quantities

Type	Thickness(mm)	Bulk	Tape and reel
3216	1.10±0.30	----	3000pcs
2012	1.25±0.20	----	3000pcs
	0.85±0.20	----	4000pcs
1608	0.8±0.15	----	4000pcs
1005	0.5±0.15	----	10000pcs
0603	0.3±0.05	----	15000pcs

11 Storage

(1) Storage period

Products which inspected in over 6 months ago should be examined and used, which can be confirmed with inspection No. marked on the container. Solder ability should be checked if this period is exceeded.

(2) Storage conditions

① Products should be storage in the warehouse on the following conditions

 Temperature: $\leq 40^{\circ}\text{C}$

 Humidity : $\leq 70\%$ relative humidity

No rapid change on temperature and humidity

② Don't keep products in corrosive gases such as sulfur, chlorine gas or acid, or it may cause oxidization of electrode, resulting in poor solder ability.

- ③ Products should be storage on the palette for the prevention of the influence from humidity, dust and so on.
- ④ Products should be storage in the warehouse without heat shock, vibration, and direct sunlight and so on.
- ⑤ Products should be storage under the airtight packaged condition.

12 Usage of Nonflammable Material

For these materials listed below, we don't use in process.

Cd, Hg, As and its compound, PCB, etc.

PBBS, PBBOs, PBDO, PBDE, PBB.

13 Usage of ODS

For ODS listed below, we don't use in process. ODS: CCL₄, HCFC, etc. ODS。

14 Flammability Class

UL 94V-1

15 Note

This product specification guarantees the quality of our product as a single unit. Please make sure that your product is evaluated and confirmed against your specifications when our product is mounted to your product.

We cannot warrant against failure caused by any use of our product that deviates from the intended use as described in this product specification.

Please return our copy of this product specification in two month after issued date with your signature of receipt. If the copy is not returned by the date, this product specification will be deemed to have been received.